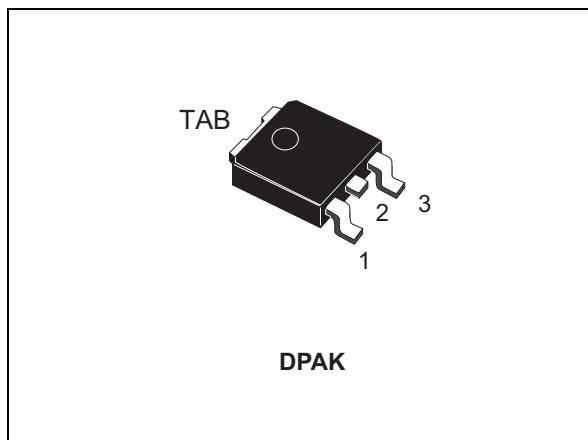


## N-channel 650 V, 0.37 Ω typ., 10 A MDmesh M2 Power MOSFET in a DPAK package

Datasheet – production data



**Figure 1. Internal schematic diagram**

### Features

| Order code | V <sub>DS</sub> | R <sub>DS(on)</sub> max | I <sub>D</sub> |
|------------|-----------------|-------------------------|----------------|
| STD13N65M2 | 650 V           | 0.43 Ω                  | 10 A           |

- Extremely low gate charge
- Excellent output capacitance (C<sub>oss</sub>) profile
- 100% avalanche tested
- Zener-protected

### Applications

- Switching applications

### Description

This device is an N-channel Power MOSFET developed using MDmesh™ M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

**Table 1. Device summary**

| Order codes | Marking | Package | Packaging     |
|-------------|---------|---------|---------------|
| STD13N65M2  | 13N65M2 | DPAK    | Tape and reel |

## Contents

|          |                                     |           |
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# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

| Symbol         | Parameter   | Value       | Unit             |
|----------------|---|-------------|------------------|
| $V_{GS}$       | Gate-source voltage                                     | $\pm 25$    | V                |
| $I_D$          | Drain current (continuous) at $T_C = 25^\circ\text{C}$  | 10          | A                |
| $I_D$          | Drain current (continuous) at $T_C = 100^\circ\text{C}$ | 6.3         | A                |
| $I_{DM}^{(1)}$ | Drain current (pulsed)                                  | 40          | A                |
| $P_{TOT}$      | Total dissipation at $T_C = 25^\circ\text{C}$           | 110         | W                |
| $dv/dt^{(2)}$  | Peak diode recovery voltage slope                       | 15          | V/ns             |
| $dv/dt^{(3)}$  | MOSFET dv/dt ruggedness                                 | 50          | V/ns             |
| $T_{sig}$      | Storage temperature                                     | - 55 to 150 | $^\circ\text{C}$ |
| $T_j$          | Max. operating junction temperature                     | 150         | $^\circ\text{C}$ |

1. Pulse width limited by safe operating area.
2.  $I_{SD} \leq 10$  A,  $di/dt \leq 400$  A/ $\mu\text{s}$ ;  $V_{DS}$  peak <  $V_{(BR)DSS}$ ,  $V_{DD}=400$  V.
3.  $V_{DS} \leq 520$  V

**Table 3. Thermal data**

| Symbol         | Parameter  | Value | Unit                      |
|----------------|--|-------|---------------------------|
| $R_{thj-case}$ | Thermal resistance junction-case max               | 1.14  | $^\circ\text{C}/\text{W}$ |
| $R_{thj-pcb}$  | Thermal resistance junction-pcb max <sup>(1)</sup> | 50    | $^\circ\text{C}/\text{W}$ |

1. When mounted on 1 inch<sup>2</sup> FR-4, 2 Oz copper board

**Table 4. Avalanche characteristics**

| Symbol   | Parameter  | Value | Unit |
|----------|--|-------|------|
| $I_{AR}$ | Avalanche current, repetitive or not repetitive (pulse width limited by $T_{jmax}$ )                 | 1.8   | A    |
| $E_{AS}$ | Single pulse avalanche energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ ; $V_{DD} = 50$ V) | 350   | mJ   |

## 2 Electrical characteristics

( $T_C = 25^\circ\text{C}$  unless otherwise specified)

**Table 5. On /off states**

| Symbol                      | Parameter                         | Test conditions   | Min. | Typ. | Max.     | Unit          |
|-----------------------------|-----------------------------------|---|------|------|----------|---------------|
| $V_{(\text{BR})\text{DSS}}$ | Drain-source breakdown voltage    | $V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$                              | 650  |      |          | V             |
| $I_{\text{DSS}}$            | Zero gate voltage drain current   | $V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}$                          |      |      | 1        | $\mu\text{A}$ |
|                             |                                   | $V_{GS} = 0 \text{ V}, V_{DS} = 650 \text{ V}, T_C = 125^\circ\text{C}$ |      |      | 100      | $\mu\text{A}$ |
| $I_{GSS}$                   | Gate-body leakage current         | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 25 \text{ V}$                       |      |      | $\pm 10$ | $\mu\text{A}$ |
| $V_{GS(\text{th})}$         | Gate threshold voltage            | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$                                | 2    | 3    | 4        | V             |
| $R_{DS(\text{on})}$         | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}, I_D = 5 \text{ A}$                              |      | 0.37 | 0.43     | $\Omega$      |

**Table 6. Dynamic**

| Symbol                      | Parameter                     | Test conditions  | Min. | Typ.  | Max. | Unit     |
|-----------------------------|-------------------------------|--|------|-------|------|----------|
| $C_{iss}$                   | Input capacitance             | $V_{GS} = 0 \text{ V}, V_{DS} = 100 \text{ V}, f = 1 \text{ MHz}$                                    | -    | 590   | -    | pF       |
| $C_{oss}$                   | Output capacitance            |  | -    | 27.5  | -    | pF       |
| $C_{rss}$                   | Reverse transfer capacitance  |  | -    | 1.1   | -    | pF       |
| $C_{oss \text{ eq.}}^{(1)}$ | Equivalent output capacitance | $V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ to } 520 \text{ V}$   | -    | 168.5 | -    | pF       |
| $R_G$                       | Intrinsic gate resistance     | $f = 1 \text{ MHz}$ open drain   | -    | 6.5   | -    | $\Omega$ |
| $Q_g$                       | Total gate charge             | $V_{DD} = 520 \text{ V}, I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}$ (see <a href="#">Figure 15</a> ) | -    | 17    | -    | nC       |
| $Q_{gs}$                    | Gate-source charge            |  | -    | 3.3   | -    | nC       |
| $Q_{gd}$                    | Gate-drain charge             |  | -    | 7     | -    | nC       |

1.  $C_{oss \text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$

**Table 7. Switching times**

| Symbol       | Parameter           | Test conditions   | Min. | Typ. | Max. | Unit |
|--------------|---------------------|---|------|------|------|------|
| $t_{d(on)}$  | Turn-on delay time  | $V_{DD} = 325 \text{ V}, I_D = 5 \text{ A}, R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$<br>(see <a href="#">Figure 14</a> and <a href="#">19</a> ) | -    | 11   | -    | ns   |
| $t_r$        | Rise time           |   | -    | 7.8  | -    | ns   |
| $t_{d(off)}$ | Turn-off delay time |   | -    | 38   | -    | ns   |
| $t_f$        | Fall time           |   | -    | 12   | -    | ns   |

**Table 8. Source drain diode**

| Symbol          | Parameter                     | Test conditions  | Min. | Typ. | Max. | Unit          |
|-----------------|-------------------------------|--|------|------|------|---------------|
| $I_{SD}$        | Source-drain current          |  | -    |      | 10   | A             |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) |  | -    |      | 40   | A             |
| $V_{SD}^{(2)}$  | Forward on voltage            | $V_{GS} = 0 \text{ V}, I_{SD} = 10 \text{ A}$  | -    |      | 1.6  | V             |
| $t_{rr}$        | Reverse recovery time         | $I_{SD} = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$<br>$V_{DD} = 60 \text{ V}$ (see <a href="#">Figure 16</a> )                             | -    | 312  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       |  | -    | 2.7  |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |  | -    | 17.5 |      | A             |
| $t_{rr}$        | Reverse recovery time         |  | -    | 464  |      | ns            |
| $Q_{rr}$        | Reverse recovery charge       | $I_{SD} = 10 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}$<br>$V_{DD} = 60 \text{ V}, T_j = 150^\circ\text{C}$<br>(see <a href="#">Figure 16</a> ) | -    | 4.1  |      | $\mu\text{C}$ |
| $I_{RRM}$       | Reverse recovery current      |  | -    | 17.5 |      | A             |

1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300  $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

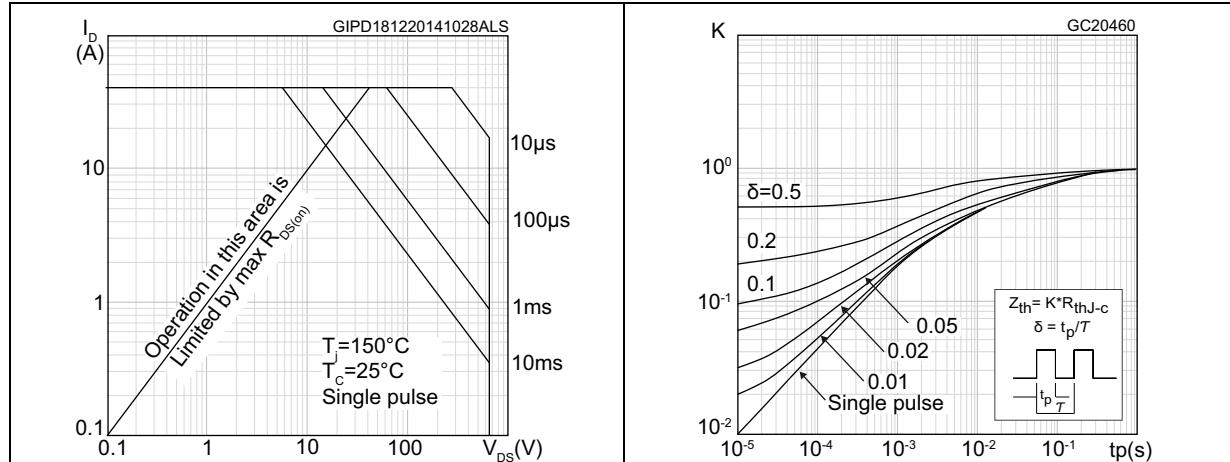


Figure 3. Thermal impedance

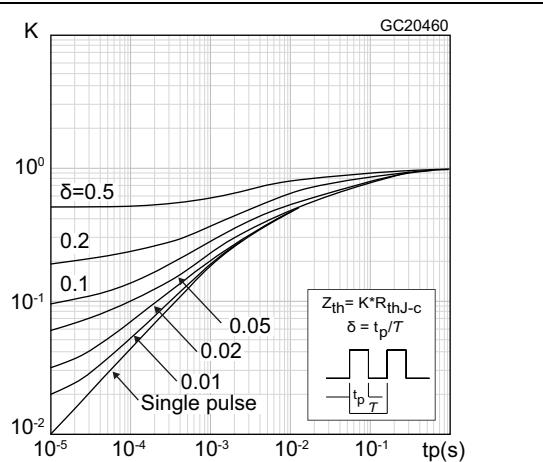


Figure 4. Output characteristics

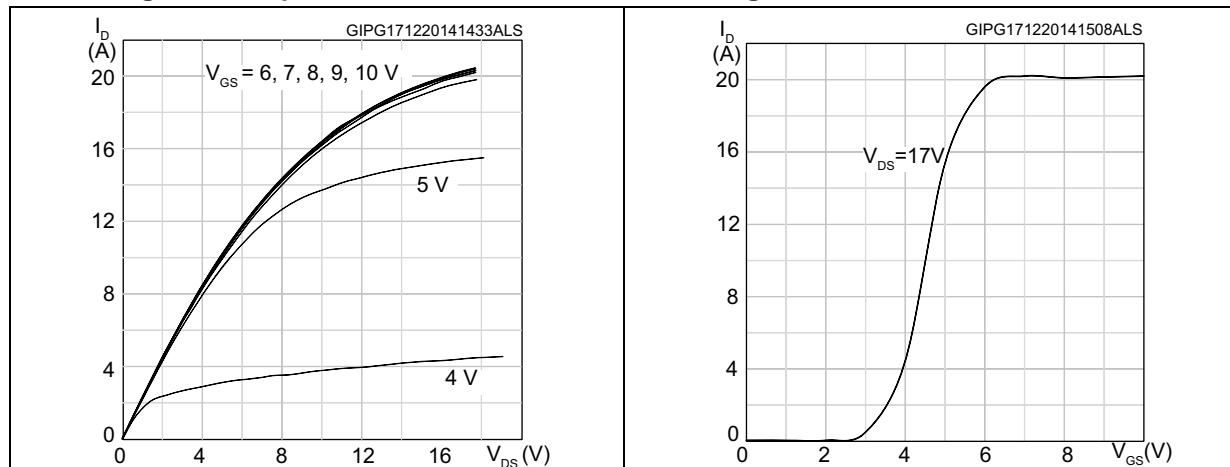


Figure 5. Transfer characteristics

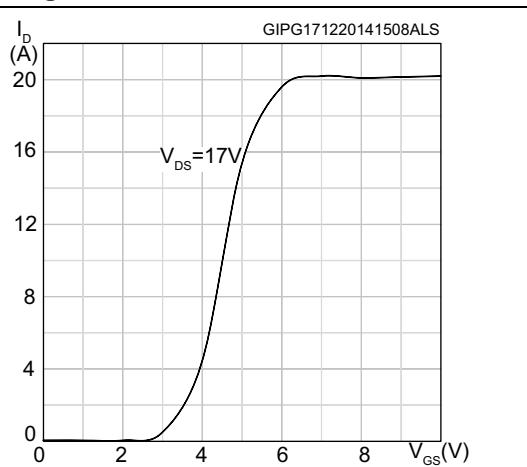
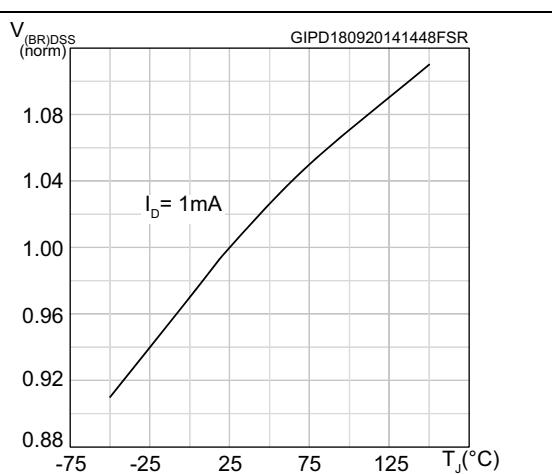
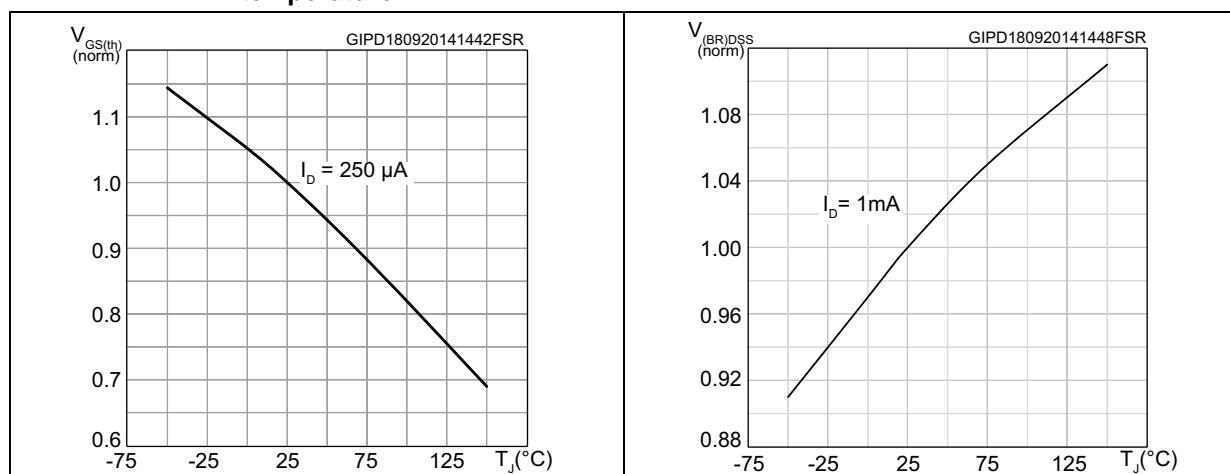
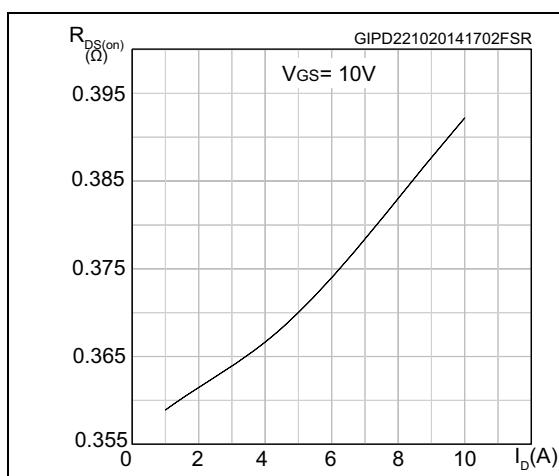
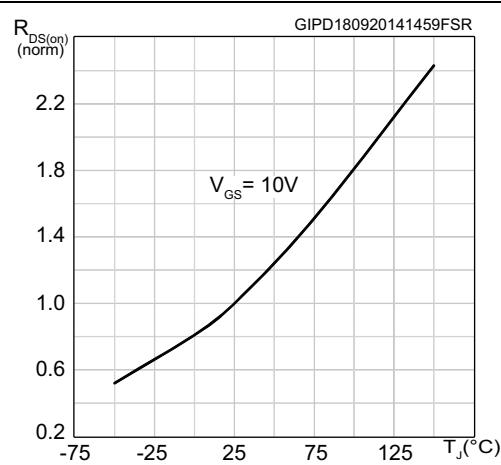
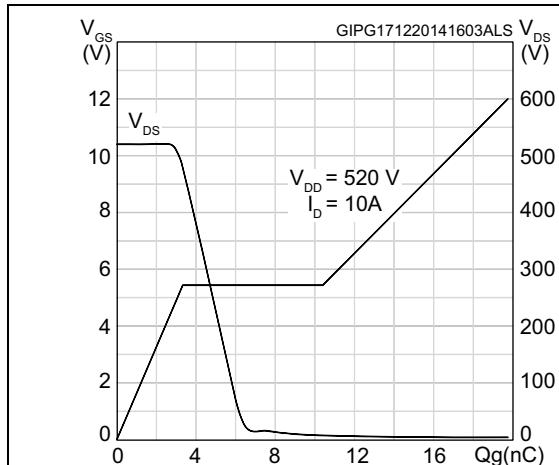
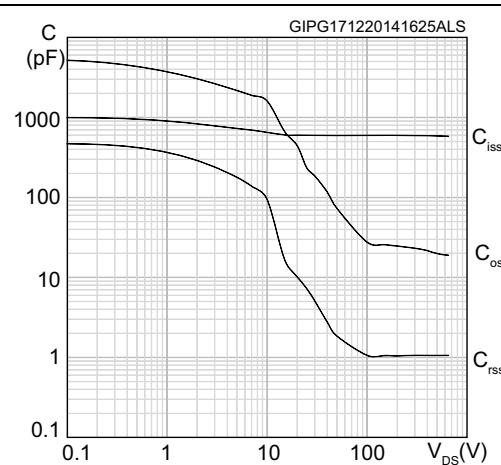
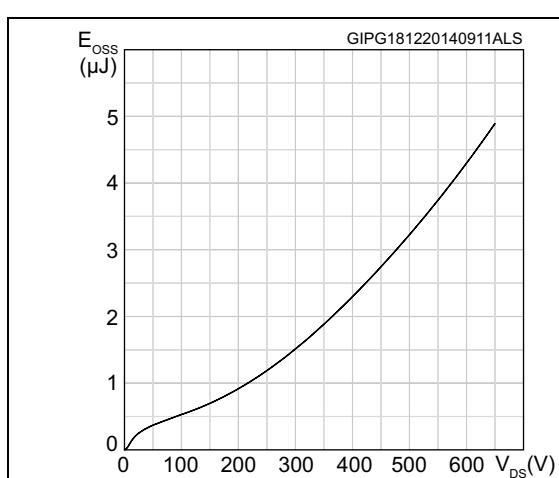
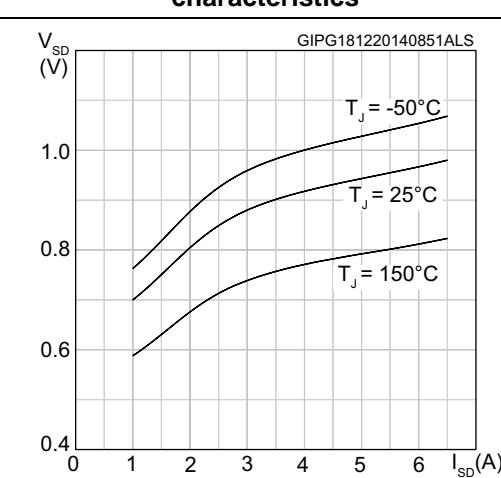


Figure 6. Normalized gate threshold voltage vs. temperature



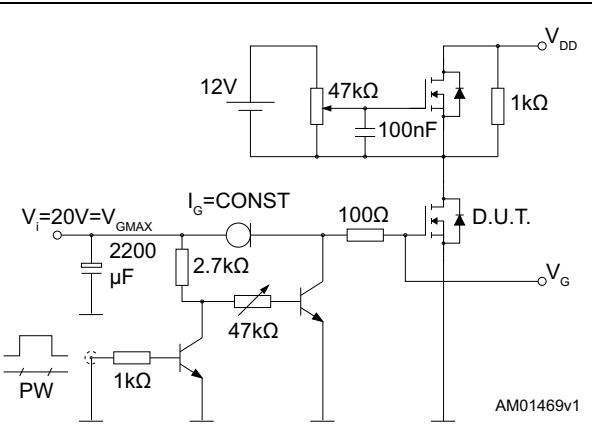
**Figure 8. Static drain-source on-resistance****Figure 9. Normalized on-resistance vs. temperature****Figure 10. Gate charge vs. gate-source voltage****Figure 11. Capacitance variations****Figure 12. Output capacitance stored energy****Figure 13. Source-drain diode forward characteristics**

### 3 Test circuits

**Figure 14. Switching times test circuit for resistive load**



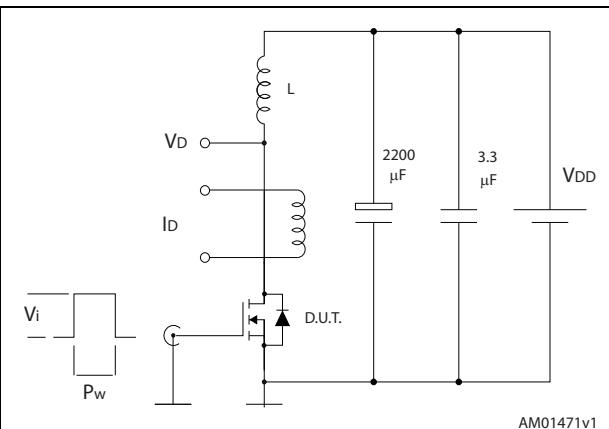
**Figure 15. Gate charge test circuit**



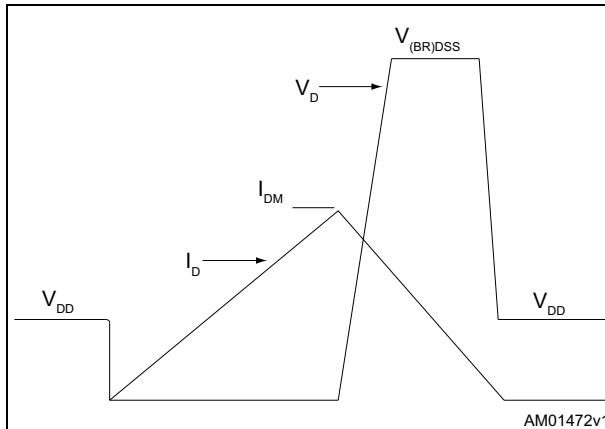
**Figure 16. Test circuit for inductive load switching and diode recovery times**



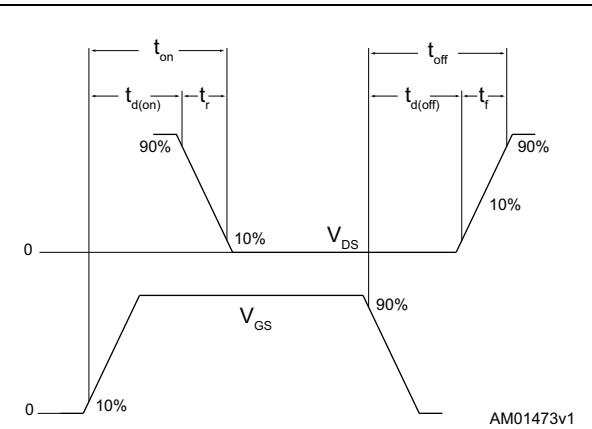
**Figure 17. Unclamped inductive load test circuit**



**Figure 18. Unclamped inductive waveform**



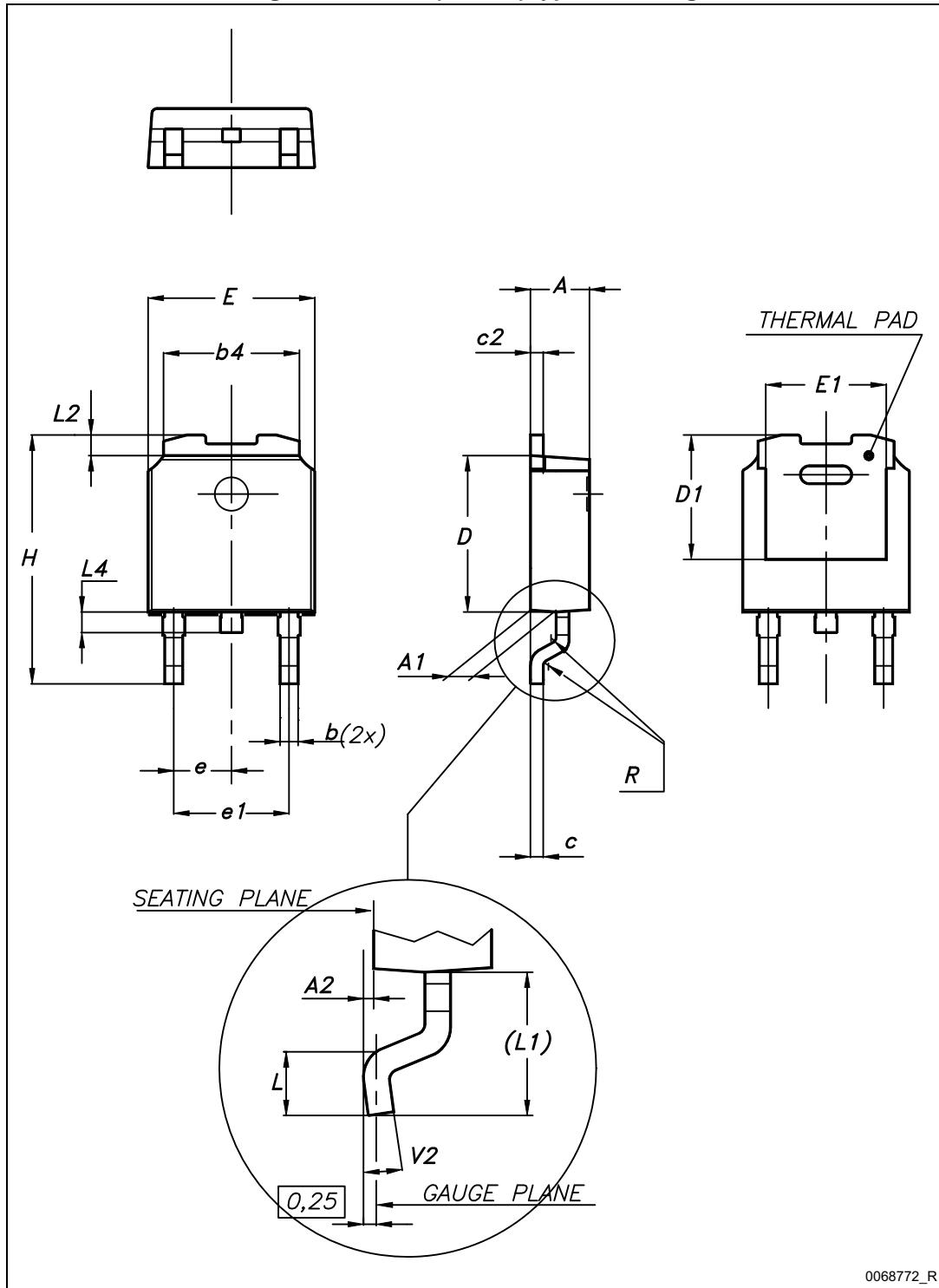
**Figure 19. Switching time waveform**



## 4 Package mechanical data

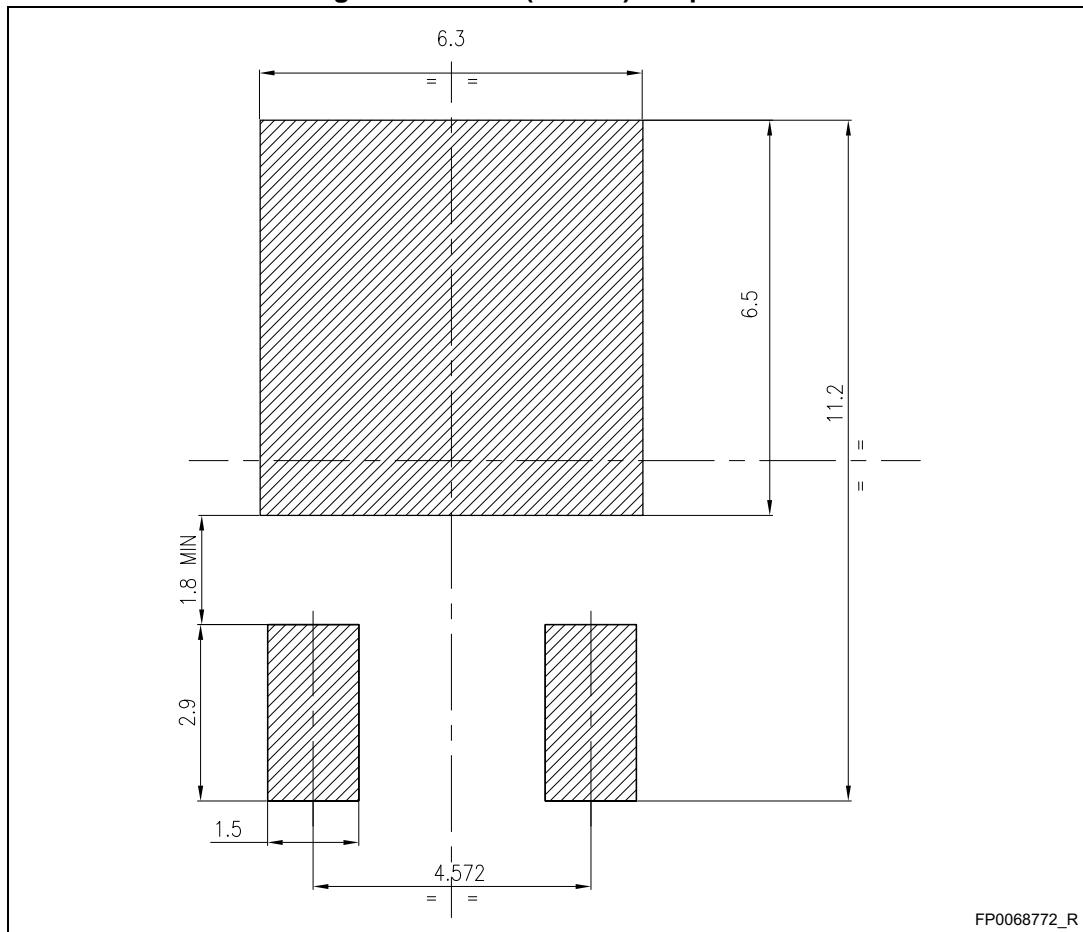
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ECOPACK® is an ST trademark.

Figure 20. DPAK (TO-252) type A drawing



**Table 9. DPAK (TO-252) type A mechanical data**

| Dim. | mm   |      |       |
|------|------|------|-------|
|      | Min. | Typ. | Max.  |
| A    | 2.20 |      | 2.40  |
| A1   | 0.90 |      | 1.10  |
| A2   | 0.03 |      | 0.23  |
| b    | 0.64 |      | 0.90  |
| b4   | 5.20 |      | 5.40  |
| c    | 0.45 |      | 0.60  |
| c2   | 0.48 |      | 0.60  |
| D    | 6.00 |      | 6.20  |
| D1   |      | 5.10 |       |
| E    | 6.40 |      | 6.60  |
| E1   |      | 4.70 |       |
| e    |      | 2.28 |       |
| e1   | 4.40 |      | 4.60  |
| H    | 9.35 |      | 10.10 |
| L    | 1.00 |      | 1.50  |
| L1   |      | 2.80 |       |
| L2   |      | 0.80 |       |
| L4   | 0.60 |      | 1.00  |
| R    |      | 0.20 |       |
| V2   | 0°   |      | 8°    |

**Figure 21. DPAK (TO-252) footprint (a)**

a. All dimensions are in millimeters

## 5 Packaging mechanical data

Figure 22. TapeTape for DPAK (TO-252)

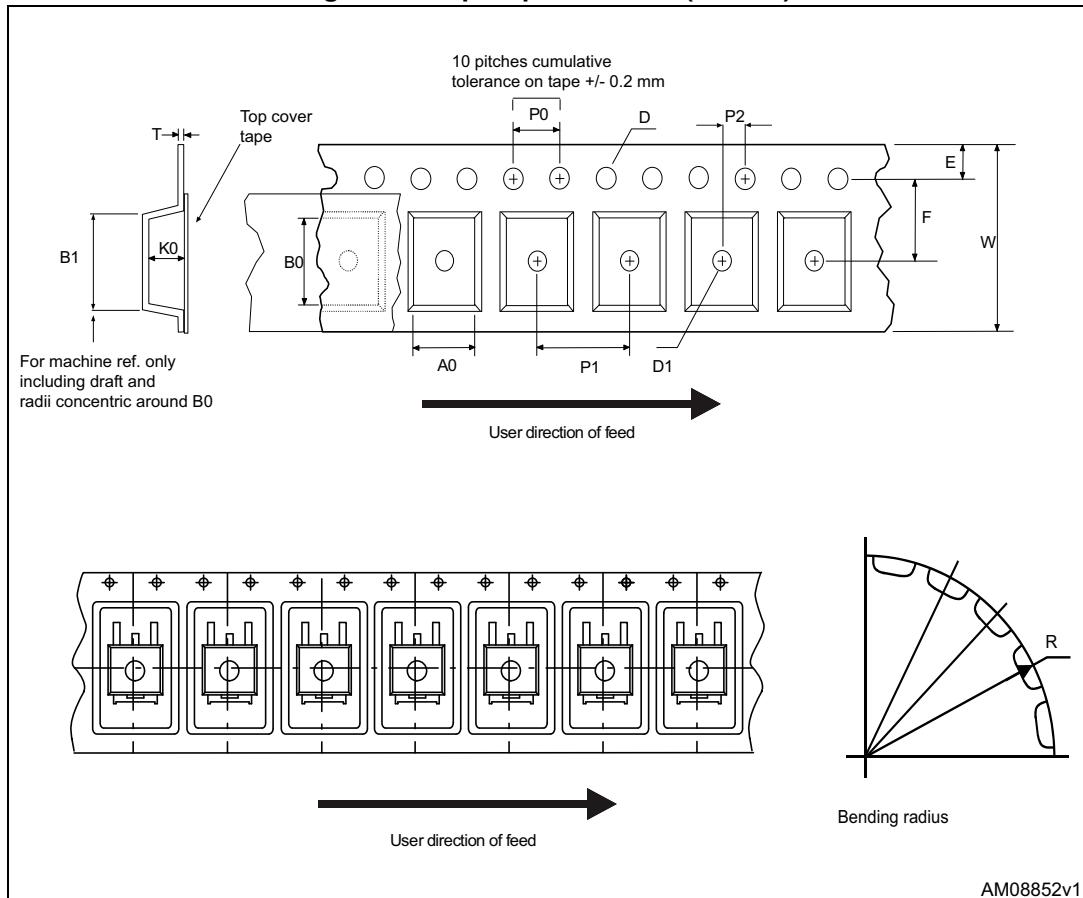


Figure 23. Reel for DPAK (TO-252)

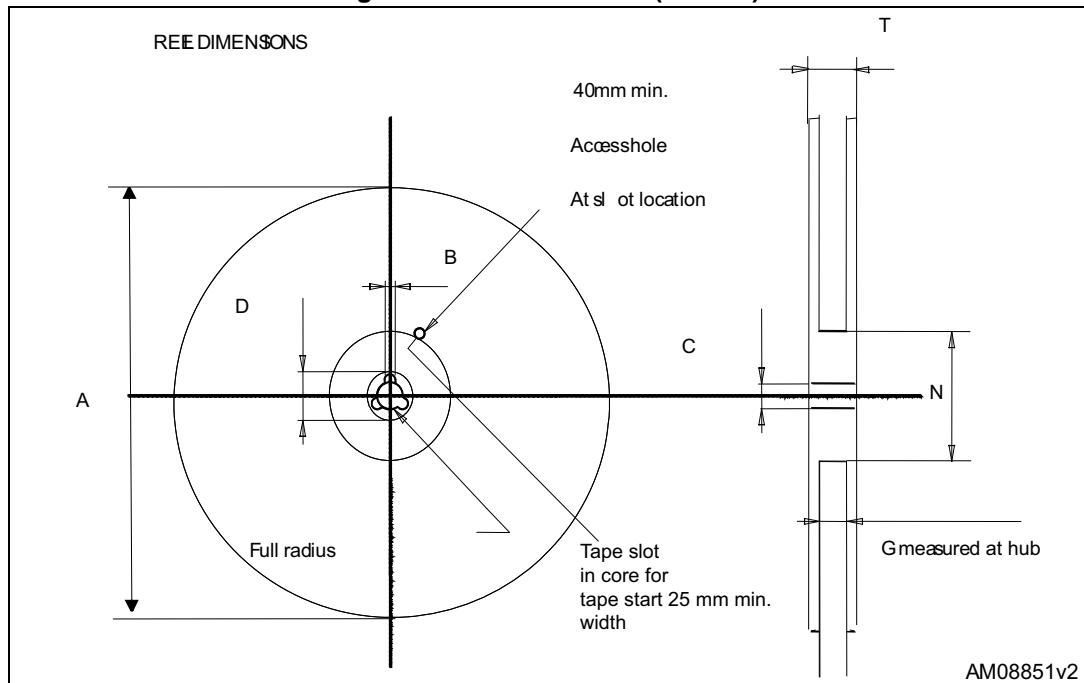


Table 10. DPAK (TO-252) tape and reel mechanical data

| Tape |      |      | Reel |           |      |
|------|------|------|------|-----------|------|
| Dim. | mm   |      | Dim. | mm        |      |
|      | Min. | Max. |      | Min.      | Max. |
| A0   | 6.8  | 7    | A    |           | 330  |
| B0   | 10.4 | 10.6 | B    | 1.5       |      |
| B1   |      | 12.1 | C    | 12.8      | 13.2 |
| D    | 1.5  | 1.6  | D    | 20.2      |      |
| D1   | 1.5  |      | G    | 16.4      | 18.4 |
| E    | 1.65 | 1.85 | N    | 50        |      |
| F    | 7.4  | 7.6  | T    |           | 22.4 |
| K0   | 2.55 | 2.75 |      |           |      |
| P0   | 3.9  | 4.1  |      | Base qty. | 2500 |
| P1   | 7.9  | 8.1  |      | Bulk qty. | 2500 |
| P2   | 1.9  | 2.1  |      |           |      |
| R    | 40   |      |      |           |      |
| T    | 0.25 | 0.35 |      |           |      |
| W    | 15.7 | 16.3 |      |           |      |

Figure 24. Revision history

**Table 11. Document revision history**

| Date        | Revision | Changes        |
|-------------|----------|----------------|
| 18-Dec-2014 | 1        | First release. |

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